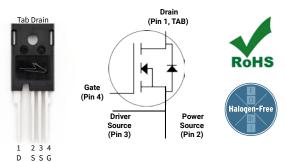


C3M0075120K

1200V 75mohm Silicon Carbide Power MOSFET N-Channel Enhancement Mode

Features

- 3rd generation Silicon Carbide (SiC) MOSFET technology
- Optimized package with separate driver source pin
- 8mm of creepage distance between drain and source
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant



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| Part Number | Package | Marking |
|-------------|----------|-------------|
| C3M0075120K | TO-247-4 | C3M0075120K |

Applications

- Renewable energy
- EV battery chargers
- High voltage DC/DC converters
- Switch Mode Power Supplies

Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Maximum Ratings (T_c = 25°C unless otherwise specified)

| Parameter | Symbol | Value | Unit | Test Conditions | Note |
|--|-----------------------------------|-------------|--------|--|-------------------|
| Drain-Source Voltage | V _{DSmax} | 1200 | | $V_{GS} = 0 V, I_{D} = 100 \mu A$ | |
| Gate-Source Voltage (dynamic) ¹ | V _{GSmax} | -8/+19 | v | AC (<i>f</i> >1 Hz) | Note 1 |
| Gate-Source Voltage (static) ² | V _{GSop} | -4/+15 | | Static | |
| Continuous Drain Current | | 30 | A | $V_{GS} = 15 \text{ V}, \text{ T}_{C} = 25^{\circ}\text{C}$ | Fig. 19 |
| | ID | 19.7 | | $V_{GS} = 15 \text{ V}, \text{T}_{C} = 100^{\circ}\text{C}$ | Note 2 |
| Pulsed Drain Current | I _{DM} | 123 | | Pulse width t_P limited by $T_{j max}$ | Fig. 22 Note 2 |
| Power Dissipation | PD | 113.6 | W | T _J = 150°C | Fig. 20 |
| Operating Junction and Storage Temperature | T _J , T _{stg} | -55 to +150 | °C | | |
| Solder Temperature | Ts | 260 | | According to JEDEC J-STD-020 | |
| Mounting Torque | M | 1 | N-m | (M2 or 6 22 corow) | |
| | Ms | 8.8 | lbf-in | (M3 or 6-32 screw) | |

Note:

¹ Recommended turn-off/turn on gate voltage V_{GSmax} = -4V...0V/+15V

² Verified by design

C3M0075120K

Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

| Parameter | Symbol | Min. | Тур. | Max. | Unit | Test Conditions | Note |
|---|----------------------|------|------|------|------|---|-----------------|
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | 1200 | _ | | | $V_{GS} = 0 \text{ V}, \text{ I}_{D} = 100 \mu\text{A}$ | |
| | N | 1.8 | 2.5 | 3.6 | V | $V_{DS} = V_{GS}, I_D = 5 \text{ mA}, T_J = 25^{\circ}\text{C}$ | Fig. 11 |
| Gate Threshold Voltage | V _{GS(th)} | _ | 2.2 | _ | | $V_{DS} = V_{GS}$, $I_D = 5$ mA, $T_J = 150^{\circ}C$ | Fig.11 |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | 1 | 50 | μA | V _{DS} = 1200 V, V _{GS} = 0 V | |
| Gate-Source Leakage Current | I _{GSS} | _ | 10 | 250 | nA | $V_{GS} = 15 V, V_{DS} = 0 V$ | |
| Drain-Source On-State Resistance | | _ | 75 | 90 | mΩ | V _{GS} = 15 V, I _D = 20 A, T _J =25°C | Fig. 4, 5, 6 |
| | R _{DS(on)} | _ | 100 | _ | | V _{GS} = 15 V, I _D = 20 A, T _J =150°C | Fig. 4, 5, 6 |
| Turana and a stance | _ | | 12 | | | V _{DS} = 20 V, I _{DS} = 20 A, T _J =25°C | Fig. 7 |
| Transconductance | g _{fs} | _ | 13 | - | S | V _{DS} = 20 V, I _{DS} = 20 A, T _J =150°C | Fig. 7 |
| Input Capacitance | Ciss | _ | 1390 | _ | | | |
| Output Capacitance | Coss | _ | 58 | _ | pF | $V_{GS} = 0 V, V_{DS} = 1000 V$ | Fig. 17, 18 |
| Reverse Transfer Capacitance | C _{rss} | _ | 2 | _ |] | f = 1 Mhz $V_{AC} = 25 \text{ mV}$ | 11,10 |
| Output Capacitance Stored Energy | E _{oss} | - | 33 | - | | | Fig. 16 |
| Turn-On Switching Energy (Body Diode FWD) | Eon | - | 270 | - | μJ | $V_{DS} = 800 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_{D} = 20 \text{ A},$ | Fig. |
| Turn Off Switching Energy (Body Diode FWD) | E _{off} | - | 77 | - | | $R_{G(ext)} = 0 \Omega, L = 156 \mu H, T_J = 150^{\circ}C$ | 26, 29 |
| Turn-On Delay Time | t _{d(on)} | - | 30 | - | | $V_{DD} = 800 \text{ V}, \text{ V}_{GS} = -4 \text{ V}/15 \text{ V}$ | Fig. 27, 28 |
| Rise Time | tr | - | 14 | - | | $I_D = 20 \text{ A}, R_{G(ext)} = 0 \Omega,$ Timing relative to V_{DS} | |
| Turn-Off Delay Time | $t_{d(off)}$ | - | 38 | - | ns | | |
| Fall Time | t _f | _ | 10 | _ |] | Inductive load | |
| Internal Gate Resistance | R _{G(int)} | _ | 9 | _ | Ω | <i>f</i> = 1 MHz, V _{AC} = 25 mV | |
| Effective Output Capacitance (Energy Related) | C _{O(er)} | _ | 67 | _ | | V _{GS} = 0V, V _{DS} = 0800V | |
| Effective Output Capacitance (Time Related) | C _{O(tr)} | _ | 96 | _ | pF | | Note 3 |
| Gate to Source Charge | Q _{gs} | _ | 17 | _ | | $V_{DS} = 800 \text{ V}, \text{ V}_{GS} = -4 \text{ V}/15 \text{ V}$ | |
| Gate to Drain Charge | Q _{gd} | _ | 18 | _ | nC | $I_{\rm D} = 20 {\rm A}$ | Fig. 12 |
| Total Gate Charge | Qg | _ | 53 | _ | 1 | Per IEC60747-8-4 pg 21 | |

Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

| Parameter | Symbol | Тур. | Max. | Unit | Test Conditions | Note |
|----------------------------------|------------------|------|------|------|---|---------|
| Diada Farward Valtage | N | 4.5 | - | v | $V_{GS} = -4 V$, $I_{SD} = 10 A$ | Fig. 8, |
| Diode Forward Voltage | V _{SD} | 4.0 | - | | $V_{GS} = -4 V$, $I_{SD} = 10 A$, $T_{J} = 150^{\circ}C$ | 9,10 |
| Continuous Diode Forward Current | Is | - | 26 | | $\gamma = 4\gamma = -25\%$ | |
| Diode Pulse Current | I _{SM} | - | 123 | A | $V_{GS} = -4 V, T_{J} = 25^{\circ}C$ | |
| Reverse Recovery Time | t _{rr} | 20 | - | nS | V_{GS} = -4 V, pulse width t _P limited by T_{jmax} | |
| Reverse Recovery Charge | Qrr | 254 | - | nC | $V_{GS} = -4 V, I_{SD} = 20 A, V_{R} = 800 V$ | |
| Peak Reverse Recovery Current | I _{rrm} | 18 | - | A | dif/dt = 3600 A/µs, T_ = 150°C | |

Thermal Characteristics

The information in this document is subject to change without notice.

| Parameter | Symbol | Тур. | Unit | Note |
|--|-----------------------|------|------|---------|
| Thermal Resistance from Junction to Case | $R_{	extsf{	heta}JC}$ | 1.1 | °C/W | Fig. 21 |

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Note:

 ${}^{3}C_{O(er)}$ a lumped capacitance that gives the same stored energy as Coss while Vds is rising from 0 to 800V

C_{oltr}, a lumped capacitance that gives the same charging time as Coss while Vds is rising from 0 to 800V



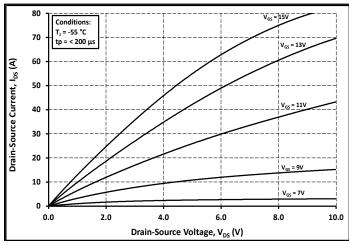
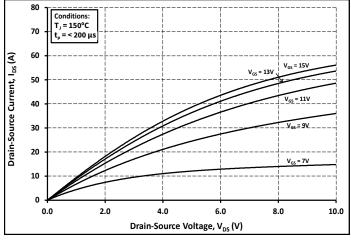
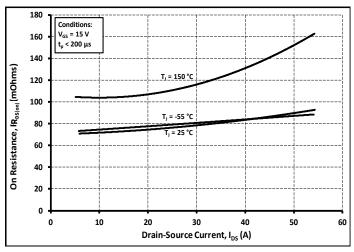
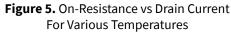


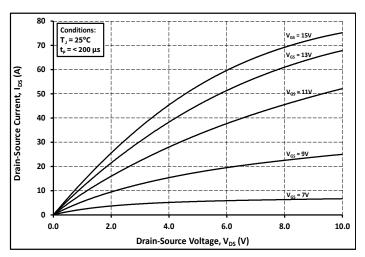
Figure 1. Output Characteristics T_J = -55°C

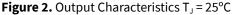












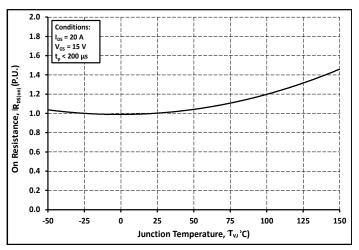
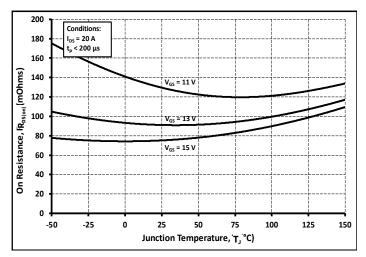
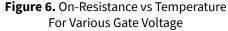


Figure 4. Normalized On-Resistance vs Temperature

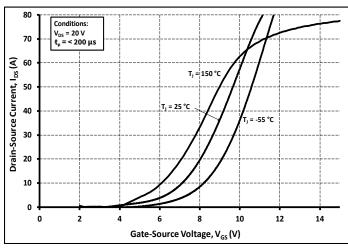


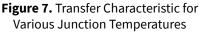


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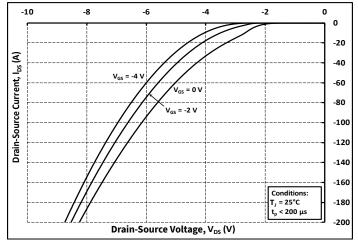


Figure 9. Body Diode Characteristic at 25°C

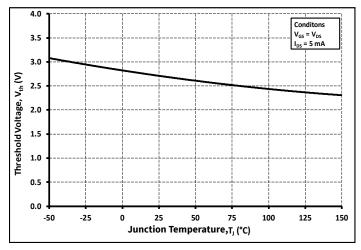


Figure 11. Threshold Voltage vs Temperature

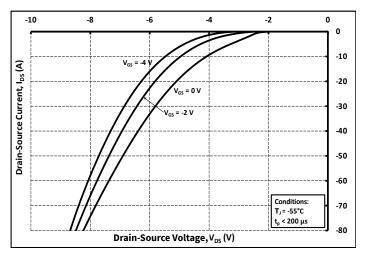


Figure 8. Body Diode Characteristic at -55°C

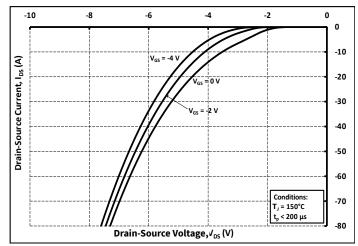
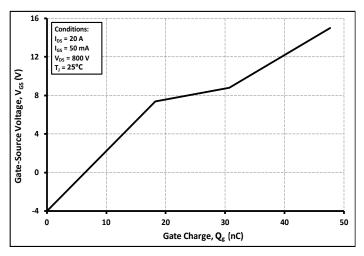


Figure 10. Body Diode Characteristic at 150°C





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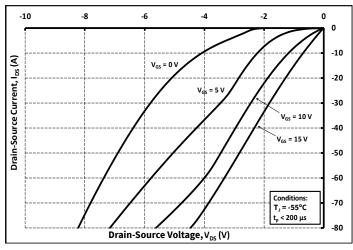


Figure 13. 3rd Quadrant Characteristic at -55°C

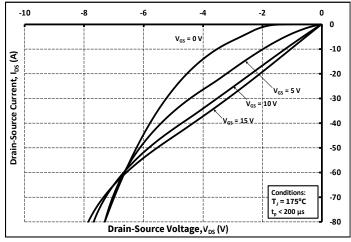
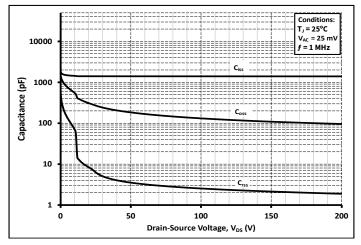
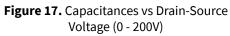


Figure 15. 3rd Quadrant Characteristic at 150°C





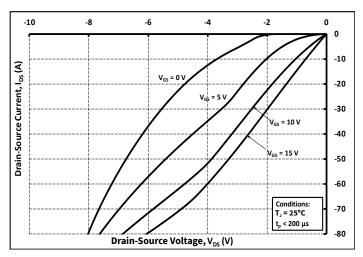


Figure 14. 3rd Quadrant Characteristic at 25°C

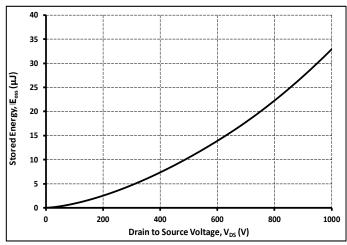
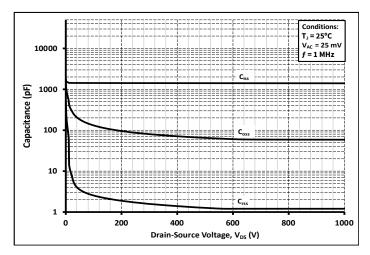
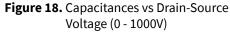


Figure 16. Output Capacitor Stored Energy

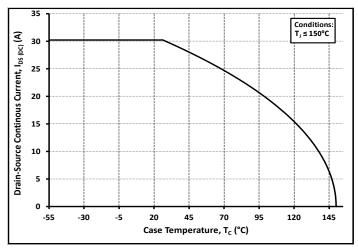




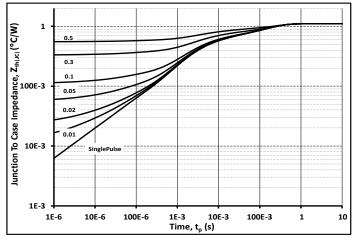
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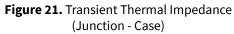
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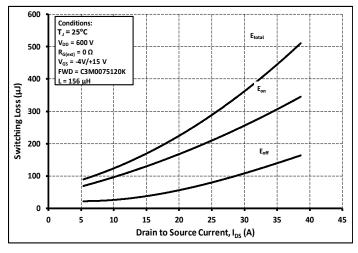


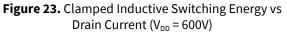












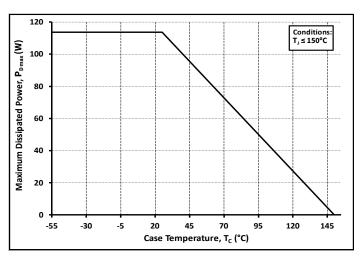


Figure 20. Maximum Power Dissipation Derating vs Case Temperature

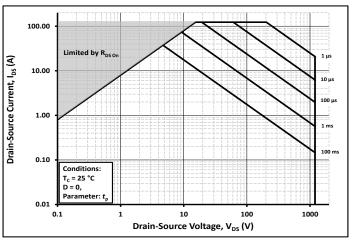


Figure 22. Safe Operating Area

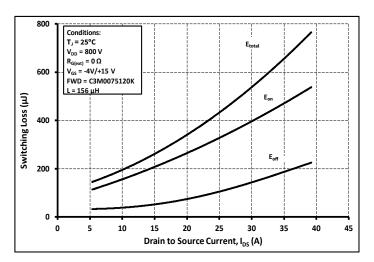


Figure 24. Clamped Inductive Switching Energy vs Drain Current (V_{DD} = 800V)

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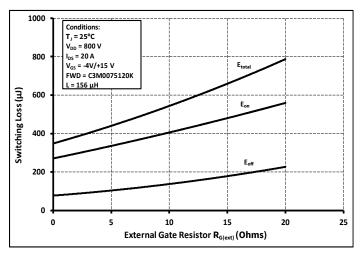


Figure 25. Clamped Inductive Switching Energy vs $R_{G(ext)}$

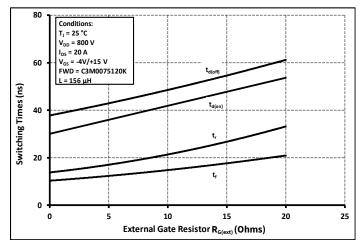


Figure 27. Switching Times vs. R_{G(ext)}

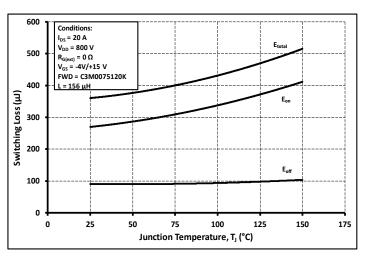


Figure 26. Clamped Inductive Switching Energy vs Temperature

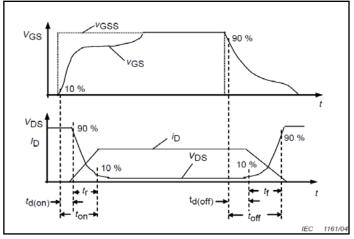


Figure 28. Switching Times Definition

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Test Circuit Schematic

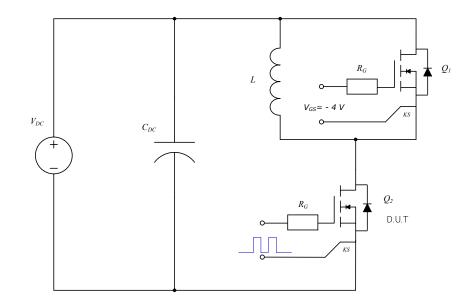


Figure 29. Clamped Inductive Switching Waveform Test Circuit

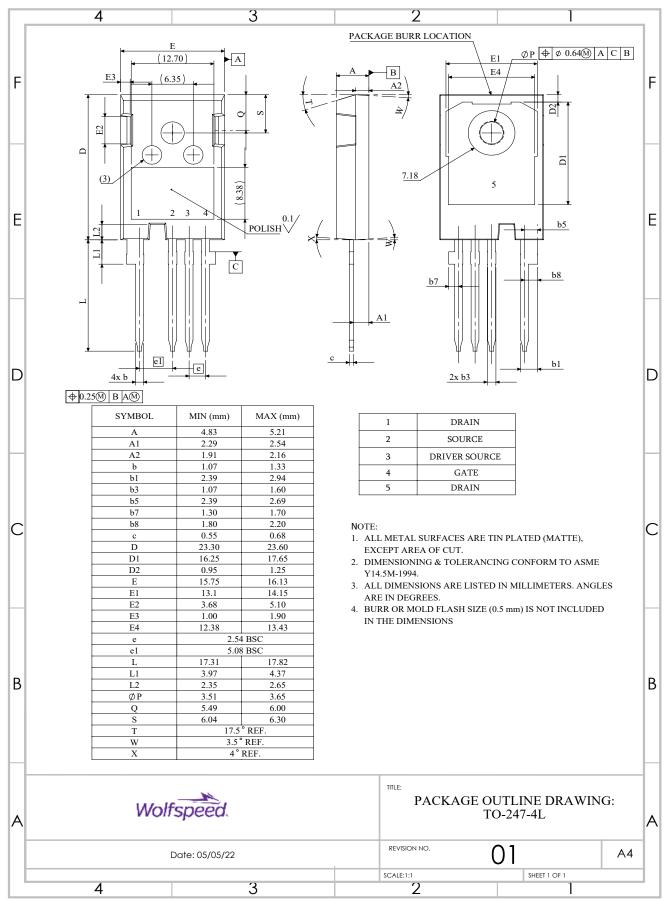
Note:

Turn-off and Turn-on switching energy and timing values measured using SiC MOSFET Body Diode as shown above.

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C3M0075120K

Package Dimensions – Package TO-247-4L

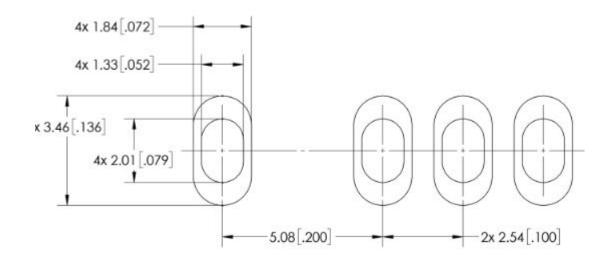


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Recommended Solder Pad Layout



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Related Links



- SPICE Models
- SiC MOSFET Isolated Gate Driver reference design
- SiC MOSFET Evaluation Board

Revision History

| Document Version | Date of Release | Description of Changes |
|------------------|-----------------|--|
| 5 | January-2021 | Tj min to -40C Tj max to 175C |
| 6 | August-2023 | ID Pulse Test Conditions Updated Package Drawing Updated Landing Pad |



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The Silicon Carbide MOSFET module switches at speeds beyond what is customarily associated with IGBT-based modules. Therefore, special precautions are required to realize optimal performance. The interconnection between the gate driver and module housing needs to be as short as possible. This will afford optimal switching time and avoid the potential for device oscillation. Also, great care is required to insure minimum inductance between the module and DC link capacitors to avoid excessive VDS overshoot.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Wolfspeed representative or from the Product Documentation sections of www.wolfspeed.com.

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REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact your Wolfspeed representative to ensure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

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